High-Speed Direct Attached Cable (DAC) Assemblies

molex

Molex High-Speed DAC Assemblies deliver a complete zSFP+and zQSFP+interconnect solution across multiple industry standards with data rates as high as 100 Gbps and off-the-shelf and custom lengths

Function across a wide variety of nextgeneration technologies and applications

Enables connections between a range of applications

Features and Benefits

10, 25, 28 and 40 Gbps with the capability of delivering 100+ Gbps Delivers high-speed connection to meet today's data rate needs

Optimized wire termination zone

Minimizes insertion loss and crosstalk



zQSFP+-tozQSFP+ DAC



Assembly



zQSFP+-to-2-zQSFP+ DAC Assembly

Twist rate insulation, separation, precision

Reduces internal noise. Maximizes signal strength



Consistency and precision of manufacturing process and shielding

Minimizes external noise. Delivers optimal signal integrity

Meet IEEE 802.3bj, InfiniBand EDR and SAS 3.0 specifications

Compatible with a wide range of equipment



zSFP+-to-zSFP+ DAC Assembly

Cable assemblies made entirely with Molex components, including **Temp-Flex cables**

Offers a one-stop shop for a complete cable solution. Eliminates a vendor. Provides superior electrical performance with Temp-Flex cables and Molex connectors

Low-smoke, zerohalogen options available for 25 and 28 Gbps cable assemblies

Offers safer cable due to less toxins and corrosive gas in case of a fire. Easy disposal. Meets **European Commission** datacenter safety and environmental

Applications

Telecommunications/Networking

Switches

Servers

Routers

Infrastructure

Test and measurement equipment

Data Communications

Storage network

Data center network

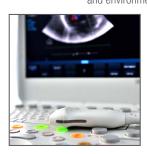
Medical

Diagnostics

Networking







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Specifications

REFERENCE INFORMATION

Packaging: Bag

Mates With: zSFP+and SFP+ Pluggable Modules; Use With: Series 100113, 100114 and 100115

Designed In: Millimeters

RoHS: Yes Halogen Free: Yes

ELECTRICAL

Data Voltage (max.): 10V DC Supply Voltage (max.): 3.47V

Supply Current, Serial ID Write (max.): 3.0mA Supply Current, Serial ID Read (max.): 1.0mA

Surge Current (max.): 30mA

Data Path

Baud Rate: 5 Gbps Bit Error Rate: 1E-12 Impedance: 100 Ohms

PHYSICAL

Housing: Die Cast Backshells: Nickel Plated Rivets: Stainless Steel

Operating Temperature: -0 to +70°C

Ordering Information

Series No.	Product	Data Rate (Gbps)	AWG	Length (m)
<u>111145</u>	zSFP+-to-zSFP+ Passive DAC Assembly	28	28, 30	0.5, 1.0, 2.0, 2.5, 3.0, 4.0, 5.0
100297	zQSFP+-to-zQSFP+ DAC Assembly		30, 32	0.5, 1.0, 1.5, 2.0, 2.5, 3.0, 3.5, 4.0, 5.0
100345	zQSFP+-to-4-zQSFP+ DAC Assembly	100	26 to 30	0.5, 1.0, 1.5, 2.0, 2.5, 3.0, 3.5, 4.0, 4.5, 5.0
100346	zQSFP+-to-2-zQSFP+ DAC Assembly			1.0, 1.5, 2.0, 2.5, 3.0, 3.5, 4.0, 4.5, 5.0
<u>74752</u>	SFP+ Passive DAC Assembly	10	24 to 30	0.3, 0.5, 1.0, 1.5, 2.0, 3.0, 4.0, 5.0, 6.0, 7.0, 8.0, 9.0, 10.0, 12.0, 13.0, 14.0, 15.0, 20.0
111040	QSFP+-to-QSFP+ DAC Assembly	40	24 to 30	0.5, 1.0, 2.0, 3.0, 4.0, 5.0, 6.0, 7.0, 8.0, 10.0, 15.0
<u>74764</u>	QSFP+-to-4-SFP+ DAC Assembly		28, 30	1.0, 2.0, 3.0, 4.0, 5.0

Low-Smoke, Zero-Halogen Versions

Series No.	Product	Data Rate (Gbps)	AWG	Length (m)
<u>111145</u> -xxx6*	zSFP+-to-zSFP+ passive DAC Assembly, LSZH	28	26, 30	0.5, 1.0, 1.5, 2.0, 2.5, 3.0, 5.0
100297-xxx6*	zQSFP+-to-zQSFP+ DAC Assembly, LSZH	25	30, 32	0.5, 1.0, 2.0 3.0, 5.0
<u>100345</u> -xxx6*	zQSFP+-to-4-zSFP+ DAC Assembly, LSZH	100	26 to 30	0.5, 1.0, 1.5, 2.0, 2.5, 3.0, 5.0
100346-xxx6*	zQSFP+-to-2-zQSFP+ DAC Assembly, LSZH			1.0, 1.5, 2.0, 2.5, 3.0, 3.5, 4.0, 4.5, 5.0

^{*}Meter makes up the "xxx" in the part numbers. For example, 111145-1106 is the part number for a 1m, 30 AWG zSFP-to-zSFP LSZH Cable Assembly.

Custom Product	Description
Contact Molex	Custom DAC Assemblies (custom length, gauge and programmed EEPROM)